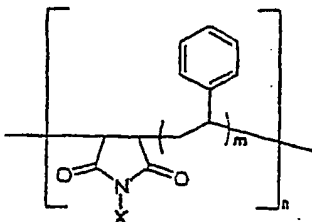


In the Claims:

Claims 1 - 17 (canceled)

Claim 18 (new) A Polyamide molding material for highly glossy, rigid polyamide molded bodies containing

- A) 100 parts of a polyamide mixture made of
- a) 0.5-95% by weight of a semicrystalline linear polyamide,
  - b) 5-99% by weight of a branched graft polyamide
    - b.1.) made of a styrene maleinimide basic structure of the general formula 1



-m standing for 1-5 and -n for 3-15, and the molecular weight of the basic structure unit being between 600 and 9000 g/mol and polyamine acid chains are grafted on at the position X and/or

- b.2.) obtained via hydrolytic polymerization of amino acids and/or lactams as basic building blocks, where components with a branching effect being added to the melt of the basic building blocks in the following compositions:
    - b.2.1.) 5-150  $\mu\text{mol/g}$  of the polymer of an at least tri-functional monomer comprising an amine or a carboxylic acid, and
    - b.2.2.) 2-100  $\mu\text{mol/g}$  of the polymer of an at least bi-functional monomer comprising a carboxylic acid, if b.2.1.) is an amine, or comprising an amine, if b.2.1.) is a carboxylic acid,
  - c) 0.5-40% by weight of an amorphous polyamide and
  - d) 0-2% by weight of carbon black, a + b + c + d together producing 100% by weight and
- B) 40-235 parts reinforcing materials and
- C) additives normal for polyamide molding materials.

Claim 19 (new) The polyamide molding material according to claim 18, wherein the polyamide mixture A) contains 0.5-80% by weight of the semicrystalline linear polyamide a), 15-98.5% by weight of the branched graft polyamide b), 1-35% by weight of amorphous polyamide c) and 0-2% by weight of carbon black d).

Claim 20 (new) The polyamide molding material according to claim 19, wherein the polyamide mixture contains 1-64.5% by weight of the semicrystalline linear polyamide a), 18-79.5% by weight of the branched graft polyamide b), 20-35% by weight of amorphous polyamide c) and 0.5-2% by weight of carbon black d).

Claim 21 (new) The polyamide molding material according to claim 18, wherein it has, at processing temperatures, melt viscosities with shear rates of  $\gamma = 200/\text{s} < 300$  Pas and at  $\gamma = 1000$  s  $< 150$  Pas.

Claim 22 (new) The polyamide molding material according to claim 18, wherein the semicrystalline linear polyamide a) is selected from PA6, PA66, PA12, PA6T, PA6T12, PA12T, whereas the terephthalic acid (T) could be replaced partially by isophthalic acid (I) or adipinic acid or mixtures thereof.

Claim 23 (new) The polyamide molding material according to claim 18, wherein graft polyamides b) are used, which are derived from PA6, PA11, PA12 and have more than 3 arms.

Claim 24 (new) The polyamide molding material according to claim 18, wherein the graft polyamides b) have a relative viscosity (1% in H<sub>2</sub>SO<sub>4</sub>, 23°C)  $< 2.2$  and a melt viscosity ( $\gamma = 500/\text{s}$ )  $< 50$  Pas 30°C above the melting temperature.

- Claim 25 (new) The polyamide molding material according to claim 24, wherein the graft polyamide b) contains inherent slip additives.
- Claim 26 (new) The polyamide molding material according to claim 18, wherein the polyamides b) have a molecular weight distribution (GPC/standard polystyrene) which corresponds approximately to the distribution of the semicrystalline polyamide a).
- Claim 27 (new) The polyamide molding material according to claim 18, wherein the amorphous polyamide c) is selected from PA MACM12, PA PACM12, or mixtures/copolyamides thereof and PA6I, PAMXDI, PA 6I/MXDI, whereas isophthalic acid (I) could be replaced partially by terephthalic acid (T) or adipinic acid and MXDA partially by PXDA.
- Claim 28 (new) The polyamide molding material according to claim 27, wherein the amorphous polyamide c) is selected from PA6I/6T and or PAMXDI/MXDT/6I/6T.
- Claim 29 (new) The polyamide molding material according to claim 18, wherein the reinforcing materials B) are selected from glass fibers, carbon fibers, minerals such as talc, mica, kaolin, wollastonite, nanocomposites, whiskers and further reinforcing materials which are common for polyamide or mixtures thereof.
- Claim 30 (new) The polyamide molding material according to claim 18, wherein the polyamide molding material A) contains common additives C).
- Claim 31 (new) The polyamide molding material according to claim 13, wherein the additives C) are selected from impact strength modifiers, UV-heat- and processing stabilizers and slip additives which can also be contained inherently in the graft polyamide.

Claim 32 (new) The molded articles produced with molding materials according to claim 18, wherein the molded articles have an outstanding surface quality, expressed by the surface gloss at an angle of  $60^\circ$ , greater than 75.

Claim 33 (new) A method of producing a molded article comprising injection molding, extrusion, extrusion blow-molding, GIT, WIT, micro-injection molding, injection blowing, pultrusion or deep drawing.

Claim 34 (new) The polyamide molding material according to claim 25, wherein the slip additives comprise long-chained n-alkylenes.